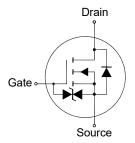
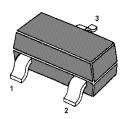
N-Channel Enhancement Mode MOSFET

Features

- Built-in G-S Protection Diode
- Typical ESD Protection HBM Class 1C

Classification	Voltage Range(V)
0A	< 125
0B	125 to < 250
1A	250 to < 500
1B	500 to < 1000
1C	1000 to < 2000
2	2000 to < 4000
3A	4000 to < 8000
3B	≥ 8000





1. Gate 2. Source 3. Drain SOT-23 Plastic Package

Applications

- Portable appliances
- · Battery management

Absolute Maximum Ratings(at Ta = 25°C unless otherwise specified)							
Parameter	Symbol	Value	Unit				
Drain-Source Voltage	V _{DS}	30	V				
Gate-Source Voltage	V _{GS}	± 12	V				
Drain Current	ID	4	А				
Peak Drain Current, Pulsed ¹⁾	I _{DM}	20	А				
Power Dissipation ²⁾	Ptot	1	W				
Max Operating Junction Temperature	Tj	150	C°				
Storage Temperature Range	T _{stg}	- 55 to + 150	C°				

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Thermal Characteristics

Parameter	Symbol	Value	Unit	
Thermal Resistance from Junction to Ambient ²⁾	$R_{\theta JA}$	125	°C/W	

¹⁾ Pulse Test: Pulse Width \leq 100 µs, Duty Cycle \leq 2%, Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.

²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

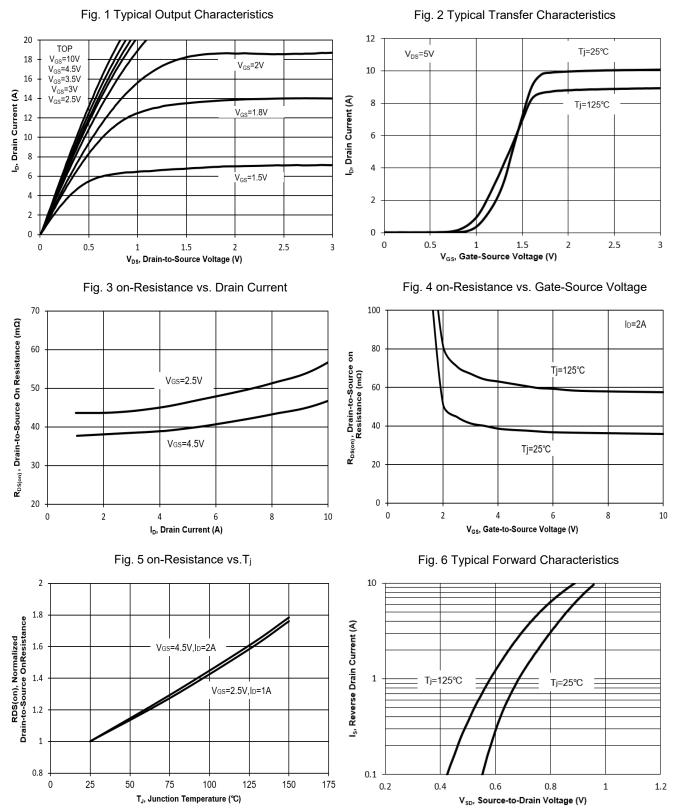


Characteristics at Ta = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS			1	1	1
Drain-Source Breakdown Voltage at I_D = 250 μ A	V _{(BR)DSS}	30	-	-	V
Zero Gate Voltage Drain Current at V _{DS} = 30 V	IDSS	-	-	1	μA
Gate-Source Leakage at V _{GS} = ± 10 V	lgss	-	-	± 10	μA
Gate-Source Threshold Voltage at V _{DS} = V _{GS} , I _D = 250 μA	V _{GS(th)}	0.4	-	1	V
Drain-Source On-State Resistance at V _{GS} = 4.5 V, I_D = 2 A at V _{GS} = 2.5 V, I_D = 1 A at V _{GS} = 1.8 V, I_D = 0.5 A	R _{DS(on)}	- - -	- - -	56 72 109	mΩ
DYNAMIC PARAMETERS					
Forward Transconductance at V_{DS} = 3 V, I_D = 2 A	g _{fs}	-	8.8	-	S
Gate resistance at V _{DS} = 0 V, V _{GS} = 0 V, f = 1 MHz	R _g	-	1.5	-	ΚΩ
Input Capacitance at V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	C _{iss}	-	387	-	pF
Output Capacitance at V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	C _{oss}	-	37	-	pF
Reverse Transfer Capacitance at V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	C _{rss}	-	10	-	pF
Gate charge total at V_{DS} = 15 V, I_D = 4 A, V_{GS} = 10 V at V_{DS} = 15 V, I_D = 4 A, V_{GS} = 4.5 V	Qg	-	14.5 7	-	nC
Gate to Source Charge at V_{DS} = 15 V, I_D = 4 A, V_{GS} = 10 V	Q _{gs}	-	1.2	-	nC
Gate to Drain Charge at V_{DS} = 15 V, I_D = 4 A, V_{GS} = 10 V	Q _{gd}	-	2.6	-	nC
Turn-On Delay Time at V _{DD} = 15 V, V _{GS} = 10 V, I _D = 1 A, R _G = 1 Ω	t _{d(on)}	-	1138	-	ns
Turn-On Rise Time at V _{DD} = 15 V, V _{GS} = 10 V, I _D = 1 A, R _G = 1 Ω	tr	-	68	-	ns
Turn-Off Delay Time at V _{DD} = 15 V, V _{GS} = 10 V, I _D = 1 A, R _G = 1 Ω	$t_{d(off)}$	-	892	-	ns
Turn-Off Fall Time at V _{DD} = 15 V, V _{GS} = 10 V, I _D = 1 A, R _G = 1 Ω	tr	-	98	-	ns
Body-Diode PARAMETERS			I	I	1
Drain-Source Diode Forward Voltage at Is = 1 A	Vsd	-	-	1.2	V
Body-Diode Continuous Current	ls	-	-	4	A
Body Diode Reverse Recovery Time at Is = 4 A, di/dt = 100 A / μs	trr	-	607	-	ns
Body Diode Reverse Recovery Charge at Is = 4 A, di/dt = 100 A / μs	Qrr	-	3.2	-	μC

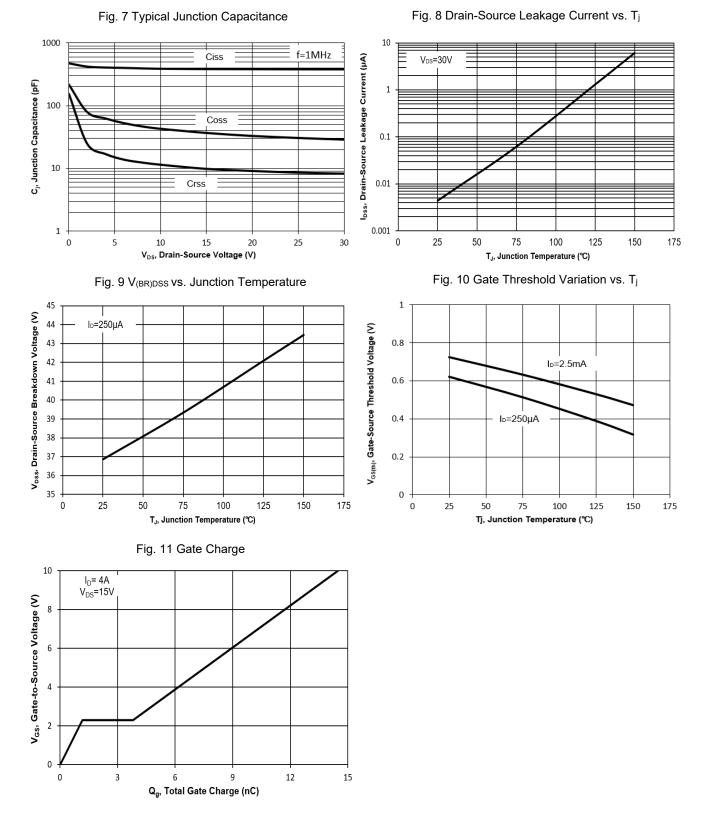


Electrical Characteristics Curves





Electrical Characteristics Curves

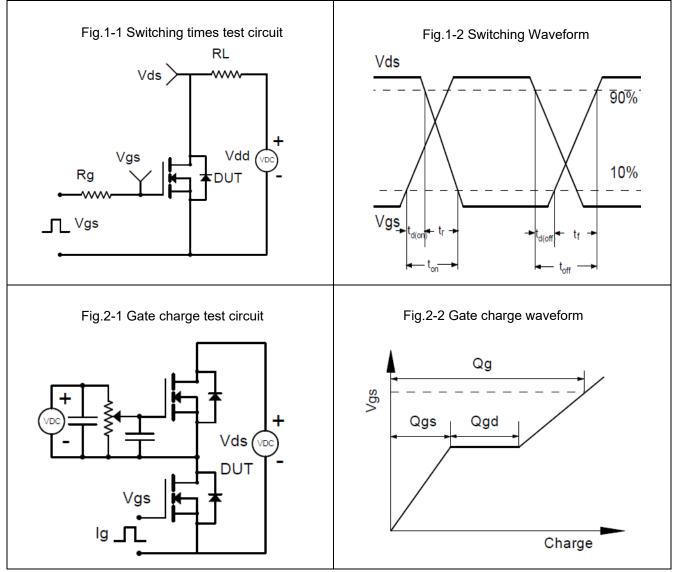




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MMFTN3324K

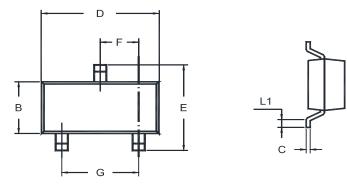
Test Circuits

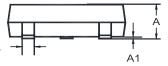




MMFTN3324K

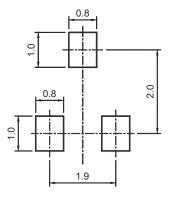
Package Outline (Dimensions in mm)





Unit	А	A1	В	С	D	Е	F	G	L	L1
	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint

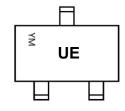


Packing information

	Package	Tape Width (mm)	Pitch		Reel Size		
			mm	inch	mm	inch	Per Reel Packing Quantity
	SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

- " UE " = Part No.
- " YM " = Date Code Marking
- " Y " = Year
- " M " = Month
- Font type: Arial



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SOT-23